

2.5V/3.3V, High Bandwidth, Hot-Insertion, 10-Bit, 2-Port, Bus Switch

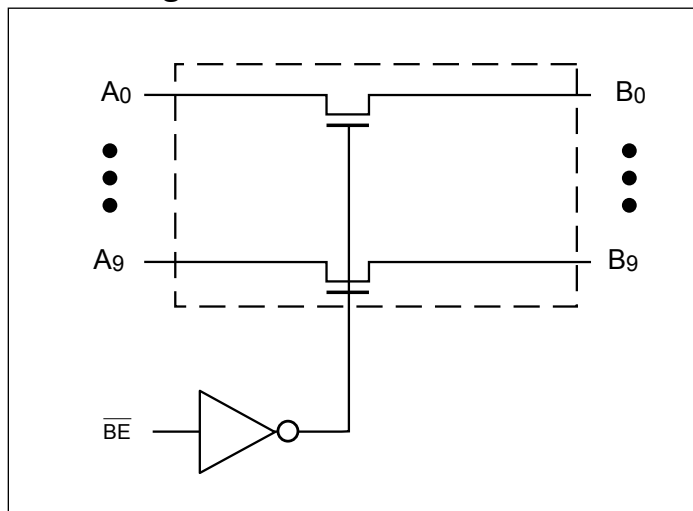
Features

- Near-Zero propagation delay
- 5-ohm switches connect inputs to outputs
- High bandwidth (>400 MHz)
- Rail-to-rail 2.5V or 3.3V switching
- 5V I/O Tolerant
- 2.5V Supply Voltage Operation
- Permits Hot-Insertion
- Packaging (Pb-free & Green):
 - 24-pin 150-mil wide plastic QSOP (Q)

Applications

- High bandwidth data switching
- Hot Docking

Block Diagram

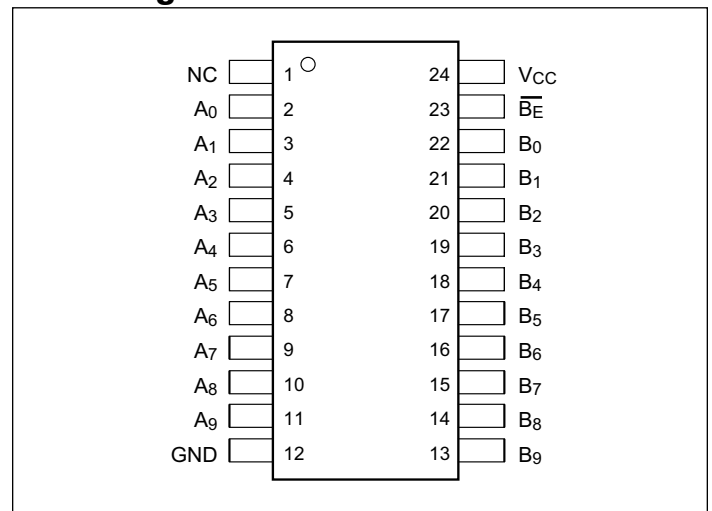


Description

PI3C series of logic circuits are produced using the company's advance submicron CMOS technology, achieving industry leading performance.

The PI3C3861-A is a 10-bit, 2.5volt or 3.3 volt, 2-port bus switch designed with a low On-Resistance (5-ohm) allowing inputs to be connected directly to outputs. The bus switch creates no additional propagational delay or additional ground bounce noise. The switches are turned ON by the Bus Enable (\overline{BE}) input signal. This device is very useful in switching signals that have high bandwidth (>400 MHz).

Pin Configuration



Truth Table⁽¹⁾

Function	\overline{BE}	A0-9
Disconnect	H	Hi-Z
Connect	L	B0-9

Note:

1. H = High Voltage Level, L = Low Voltage Level
Hi-Z = High Impedance

Pin Description

Pin Name	Description
\overline{BE}	Bus Enable Input (Active LOW)
A0-9	Bus A
B0-9	Bus B
GND	Ground
VCC	Power

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	-65°C to +150°C
Ambient Temperature with Power Applied	-40°C to +85°C
Supply Voltage to Ground Potential (Inputs & V _{CC} Only) ..	-0.5V to +4.6V
Supply Voltage to Ground Potential (Outputs & D/O Only) ..	-0.5V to +4.6V
DC Input Voltage	-0.5V to +5.5V
DC Output Current.....	120mA
Power Dissipation	0.5W

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics (Over Operating Range, T_A = -40°C to +85°C, V_{CC} = 3.3V ±10%)

Parameters	Description	Test Conditions ⁽¹⁾	Min.	Typ ⁽²⁾	Max.	Units
V _{IH}	Input HIGH Voltage	Guaranteed Logic HIGH Level	2.0			V
V _{IL}	Input LOW Voltage	Guaranteed Logic LOW Level	-0.5		0.8	
I _{IH}	Input HIGH Current	V _{CC} = Max., V _{IN} = V _{CC}			±1	μA
I _{IL}	Input LOW Current	V _{CC} = Max., V _{IN} = GND			±1	
I _{OZH}	High Impedance Output Current	0 ≤ A, B ≤ V _{CC}			±1	
V _{IK}	Clamp Diode Voltage	V _{CC} = Min., I _{IN} = -18mA		-0.73	-1.2	V
R _{ON}	Switch On-Resistance ⁽³⁾	V _{CC} = Min., V _{IN} = 0V, I _{ON} = 48mA		5	7	Ω
		V _{CC} = Min., V _{IN} = 2.4V, I _{ON} = 15mA		8	15	

Notes:

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at V_{CC} = 3.3V, T_A = 25°C ambient and maximum loading.
- Measured by the voltage drop between A and B pin at indicated current through the switch. On-Resistance is determined by the lower of the voltages on the two (A,B) pins.

Capacitance (T_A = 25°C, f = 1 MHz)

Parameters ⁽¹⁾	Description	Test Conditions	Typ.	Units
C _{IN}	Input Capacitance	V _{IN} = 0V	6.0	pF
C _{OFF}	A/B Capacitance, Switch Off		5.0	
C _{ON}	A/B Capacitance, Switch On		10.0	

Notes:

- This parameter is determined by device characterization but is not production tested.

Power Supply Characteristics

Parameters ⁽⁴⁾	Description	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Units
I _{CC}	Quiescent Power Supply Current	V _{CC} = Max.	V _{IN} = GND or V _{CC}		260	500	μA

Notes:

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
- Typical values are at V_{CC} = 3.3V, +25°C ambient.
- Per TTL driven input (control input only); A and B pins do not contribute to I_{CC}.
- This current applies to the control inputs only and represent the current required to switch internal capacitance at the specified frequency. The A and B inputs generate no significant AC or DC currents as they transition. This parameter is not tested, but is guaranteed by design.

Switching Characteristics over 3.3V Operating Range

Parameters	Description	Test Conditions	Com.		
			Min.	Max.	Units
t _{PLH} t _{PHL}	Propagation Delay ^(1,2) Ax to Bx, Bx to Ax	C _L = 50pF R _L = 500-ohm		0.25	ns
t _{PZH} t _{PZL}	Bus Enable Time BE to Ax or Bx		1.5	6.5	
t _{PHZ} t _{PLZ}	Bus Disable Time BE to Ax or Bx		1.5	5.5	

Notes:

- This parameter is guaranteed but not tested on Propagation Delays.
- The bus switch contributes no propagational delay other than the RC delay of the On-Resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns for 50pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

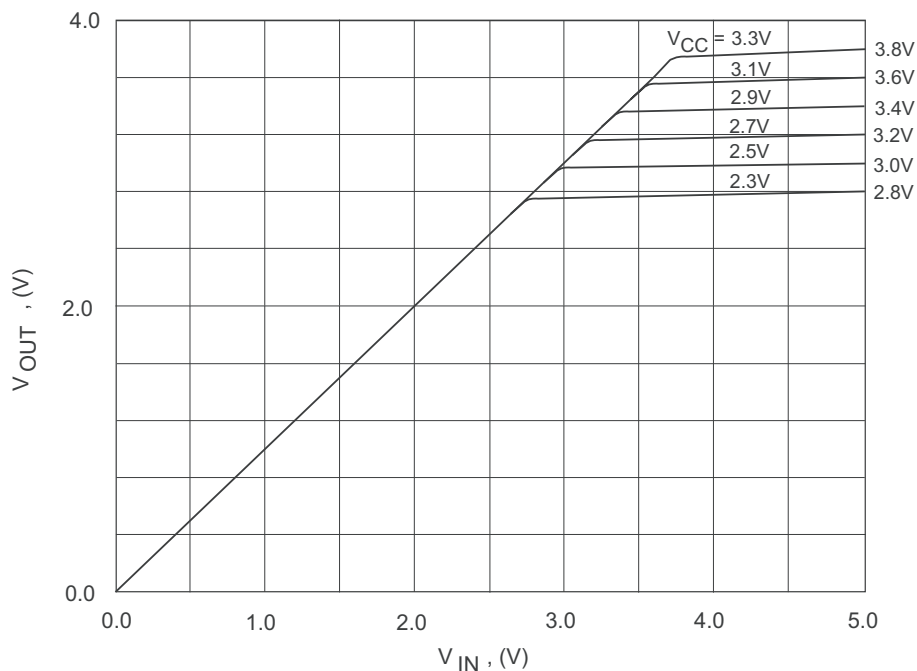
Switching Characteristics over 2.5V Operating Range

Parameters	Description	Test Conditions	Com.		
			Min.	Max.	Units
t _{PLH} t _{PHL}	Propagation Delay ^(1,2) Ax to Bx, Bx to Ax	C _L = 50pF R _L = 500-ohm		0.25	ns
t _{PZH} t _{PZL}	Bus Enable Time BE to Ax or Bx		1.5	9.8	
t _{PHZ} t _{PLZ}	Bus Disable Time BE to Ax or Bx		1.5	8.3	

Notes:

- This parameter is guaranteed but not tested on Propagation Delays.
- The bus switch contributes no propagational delay other than the RC delay of the On-Resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns for 50pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

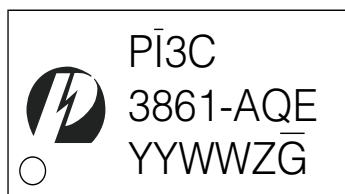
PI3C3861-A



Output Voltage vs. Input Voltage over Various Supply Voltages

Part Marking

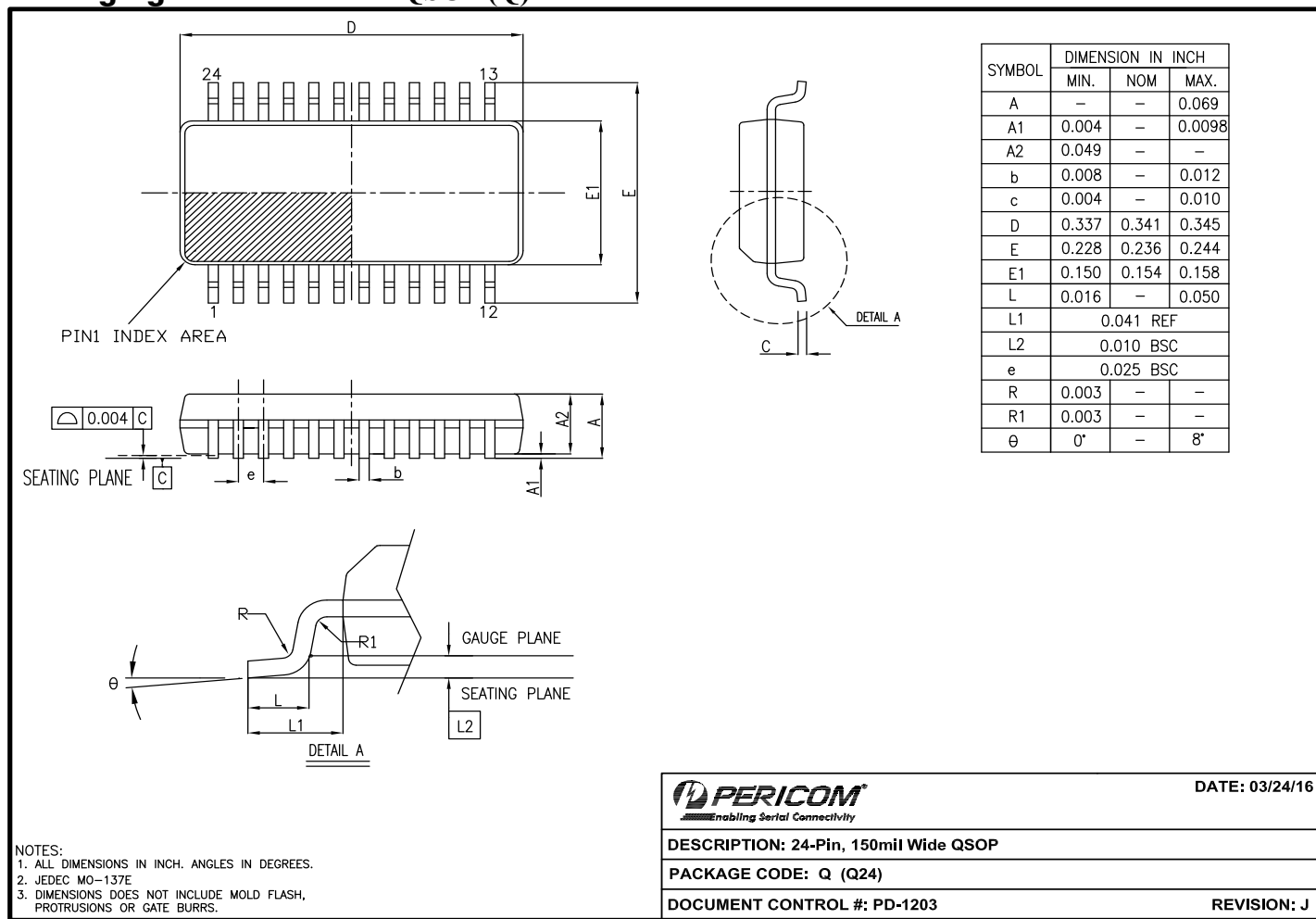
Q Package



YYWW: Date Code (Year & Workweek)

1st G: Assembly Site Code

2nd G: Fab Site Code

PI3C3861-A
Packaging Mechanical: 24-QSOP (Q)


16-0059

For latest package info.

 please check: <http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/>
Ordering Information

Ordering Code	Package Code	Package Description
PI3C3861-AQEX	Q	24-pin, 150mil Wide (QSOP)

Notes:

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
2. See <http://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free. Thermal characteristics can be found on the company web site at www.diodes.com/design/support/packaging/
3. E = Pb-free and Green
4. X suffix = Tape/Reel

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